

November 2013

ISL9R1560PF2 15A, 600V, STEALTH™ Diode

Feature

- Stealth Recovery t_{rr} = 29.4 ns (@ I_F = 15 A)
- Max Forward Voltage, V_F = 2.2 V (@ T_C = 25°C)
- 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

Applications

- · Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- · Snubber Diode

Description

The ISL9R1560PF2 is a STEALTHTM diode optimized for low loss performance in high frequency hard switched applications. The STEALTHTM family exhibits low reverse recovery current (I_RR) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{RR} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTHTM diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

Package Symbol



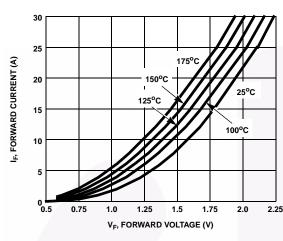


Device Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Rating	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V _R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current (T _C = 25°C)	15	Α
I _{FRM}	Repetitive Peak Surge Current (20 kHz Square Wave)	30	Α
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	200	Α
P _D	Power Dissipation	30	W
E _{AVL}	Avalanche Energy (1 A, 40 mH)	20	mJ
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C
T _L	Maximum Temperature for Soldering Leads at 0.063in (1.6 mm) from Case for 10s	300	°C

CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Min - -	Тур	Max	Unit
Min -	Тур	Max	Unit
Min - -	Тур	Max	Unit
-	T		Unit
-	T		
-	-	100	μА
	-	1.0	m/
	•		
-	1.8	2.2	V
-	1.65	2.0	V
-	62	1	рF
	•		
-	25	30	ns
-	35	40	ns
-	29.4	-	ns
-	3.5	-	Α
-	57	-	nC
-	90	-	ns
-	2.0	-	
-	5.0	-	Α
-	275	-	nC
-	52	-	ns
-	1.36	-	
-	13.5	-	Α
-	390	-	nC
-	800	-	Α/μ
-	-	4.1	°C/
		- 35 - 29.4 - 3.5 - 57 - 90 - 2.0 - 5.0 - 275 - 52 - 1.36 - 13.5 - 390	- 35 40 - 29.4 3.5 57 90 2.0 5.0 275 52 1.36 13.5 390 -



Typical Performance Curves

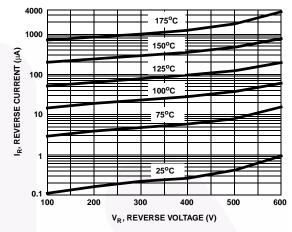
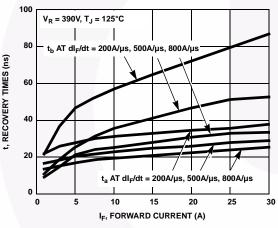


Figure 1. Forward Current vs Forward Voltage

Figure 2. Reverse Current vs Reverse Voltage



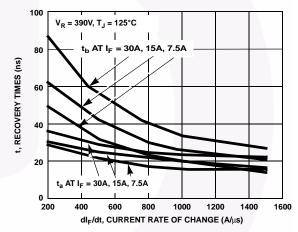
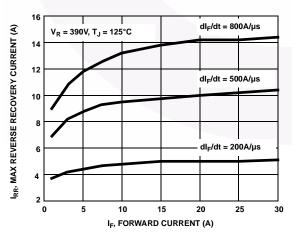


Figure 3. t_a and t_b Curves vs Forward Current

Figure 4. t_a and t_b Curves vs dl_F/dt



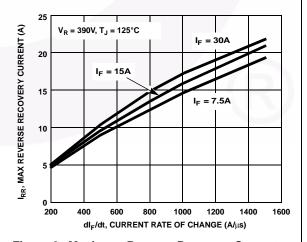


Figure 5. Maximum Reverse Recovery Current vs
Forward Current

Figure 6. Maximum Reverse Recovery Current vs dl_F/dt

$V_R = 390V, T_J = 125^{\circ}C$ REVERSE RECOVERY SOFTNESS FACTOR I_F = 30A 2.0 1.5 1.0 0.5 800 1000 1200 dl_F/dt, CURRENT RATE OF CHANGE (A/μs) Figure 7. Reverse Recovery Softness Factor vs

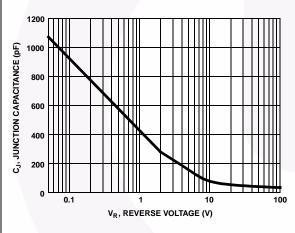
Typical Performance Curves (Continued)

V_R = 390V, T_J = 125°C REVERSE RECOVERED CHARGE (nC) I_F = 30A 600 500 I_F = 15A 400 200 800 1000 1200 1400 dl_E/dt, CURRENT RATE OF CHANGE (A/µs)

700

dl_F/dt

Figure 8. Reverse Recovered Charge vs dl_E/dt



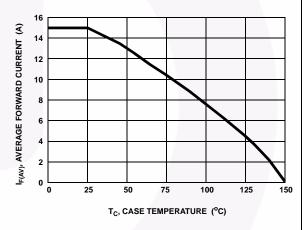


Figure 9. Junction Capacitance vs Reverse Voltage

Figure 10. DC Current Derating Curve

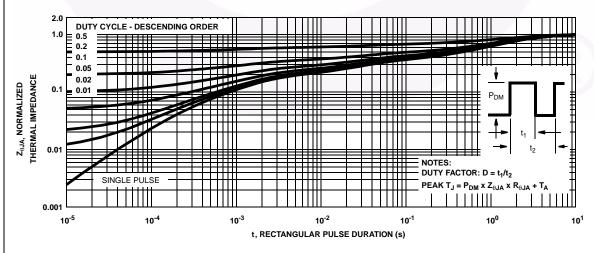
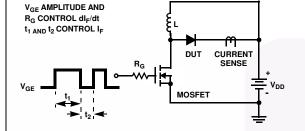


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit and Waveforms



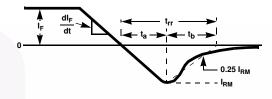
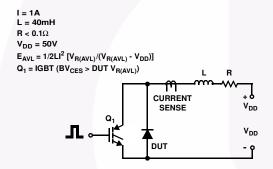


Figure 12. t_{rr} Test Circuit

Figure 13. t_{rr} Waveforms and Definitions



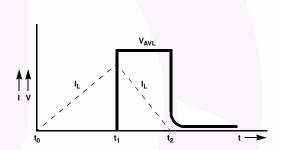


Figure 14. Avalanche Energy Test Circuit

Figure 15. Avalanche Current and Voltage Waveforms

Mechanical Dimensions

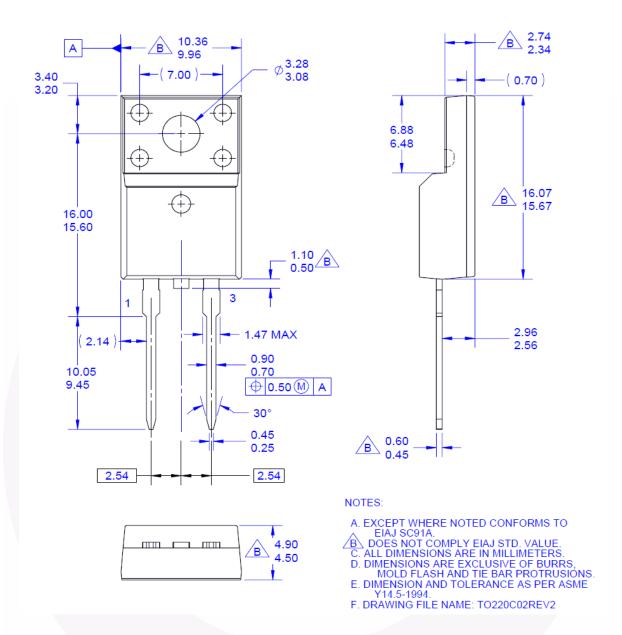


Figure 16. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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